

NPN Silicon RF Transistor

- Low noise amplifier for low current applications
- Collector design supports 5V supply voltage
- For oscillators up to 3.5 GHz
- Low noise figure 1.0 dB at 1.8 GHz
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Type	Marking	Pin Configuration			Package
BFR360F	FBs	1 = B	2 = E	3 = C	TSFP-3

Maximum Ratings at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	6	V
Collector-emitter voltage	V_{CES}	15	
Collector-base voltage	V_{CBO}	15	
Emitter-base voltage	V_{EBO}	2	
Collector current	I_C	35	mA
Base current	I_B	4	
Total power dissipation ¹⁾ $T_S \leq 98^\circ\text{C}$	P_{tot}	210	mW
Junction temperature	T_J	150	$^\circ\text{C}$
Storage temperature	T_{Stg}	-55 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R_{thJS}	≤ 250	K/W

¹ T_S is measured on the collector lead at the soldering point to the pcb

²For calculation of R_{thJA} please refer to Application Note AN077 Thermal Resistance

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

DC Characteristics

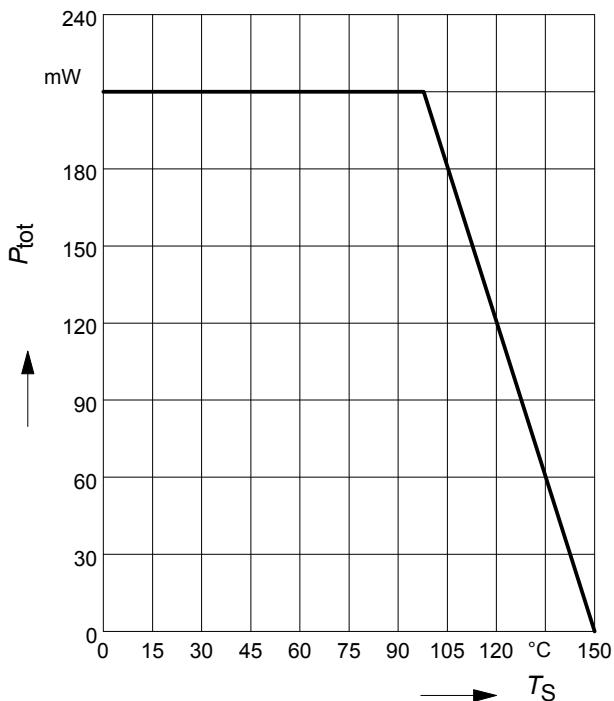
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	6	9	-	V
Collector-emitter cutoff current $V_{CE} = 4 \text{ V}, V_{BE} = 0$ $V_{CE} = 10 \text{ V}, V_{BE} = 0, T_A = 85^\circ\text{C}$	I_{CES}	-	1	30	nA
Verified by random sampling		-	2	50	
Collector-base cutoff current $V_{CB} = 4 \text{ V}, I_E = 0$	I_{CBO}	-	1	30	
Emitter-base cutoff current $V_{EB} = 1 \text{ V}, I_C = 0$	I_{EBO}	-	1	500	
DC current gain $I_C = 15 \text{ mA}, V_{CE} = 3 \text{ V}, \text{pulse measured}$	h_{FE}	90	120	160	-

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling)					
Transition frequency $I_C = 15 \text{ mA}, V_{CE} = 3 \text{ V}, f = 1 \text{ GHz}$	f_T	11	14	-	GHz
Collector-base capacitance $V_{CB} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0 \text{ , emitter grounded}$	C_{cb}	-	0.32	0.5	pF
Collector emitter capacitance $V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0 \text{ , base grounded}$	C_{ce}	-	0.2	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{CB} = 0 \text{ , collector grounded}$	C_{eb}	-	0.4	-	
Minimum noise figure $I_C = 3 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}}, f = 1.8 \text{ GHz}$	NF_{min}	-	1	-	dB
Power gain, maximum available ¹⁾ $I_C = 15 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 1.8 \text{ GHz}$ $f = 3 \text{ GHz}$	G_{ma}	-	15.5	-	
Transducer gain $I_C = 15 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50\Omega, f = 1.8 \text{ GHz}$ $f = 3 \text{ GHz}$	$ S_{21e} ^2$	-	13	-	dB
Third order intercept point at output ²⁾ $V_{CE} = 3 \text{ V}, I_C = 15 \text{ mA}, f = 1.8 \text{ GHz}, Z_S = Z_L = 50\Omega$	IP_3	-	24	-	dBm
1dB compression point at output $I_C = 15 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50\Omega, f = 1.8 \text{ GHz}$	$P_{-1\text{dB}}$	-	9	-	

¹ $G_{\text{ma}} = |S_{21e}| / S_{12e} \left(k - (k^2 - 1) \right)^{1/2}$
²IP3 value depends on termination of all intermodulation frequency components.
Termination used for this measurement is 50Ω from 0.1 MHz to 6 GHz

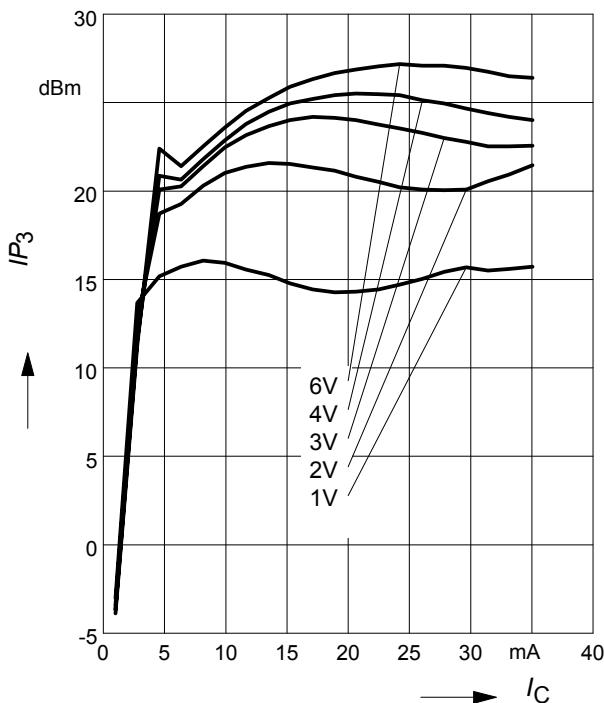
Total power dissipation $P_{\text{tot}} = f(T_S)$



Third order Intercept Point $I/P_3=f(I_C)$

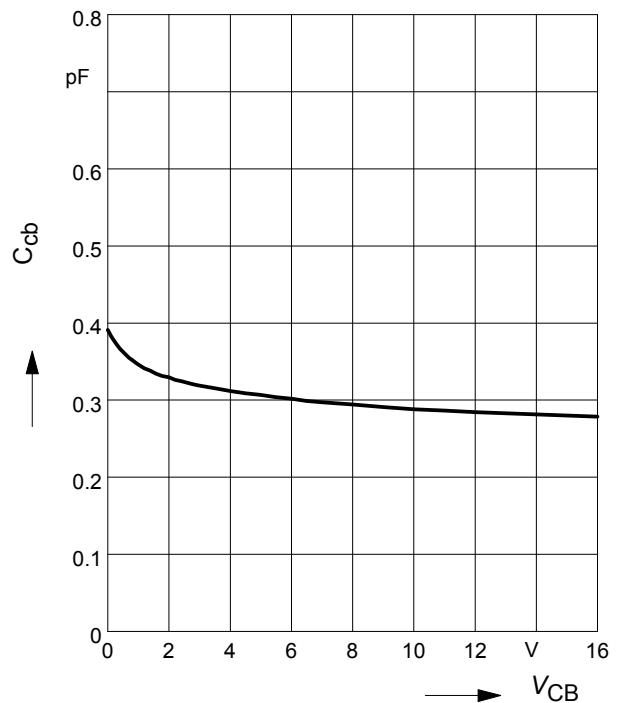
(Output, $Z_S=Z_L=50\Omega$)

V_{CE} = parameter, $f = 1.8\text{GHz}$



Collector-base capacitance $C_{cb} = f(V_{CB})$

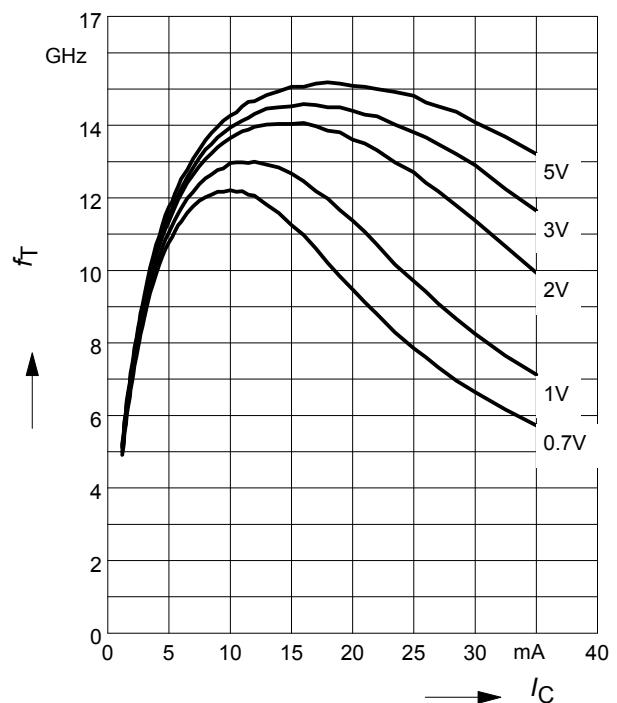
$f = 1\text{MHz}$



Transition frequency $f_T = f(I_C)$

$f = 1\text{GHz}$

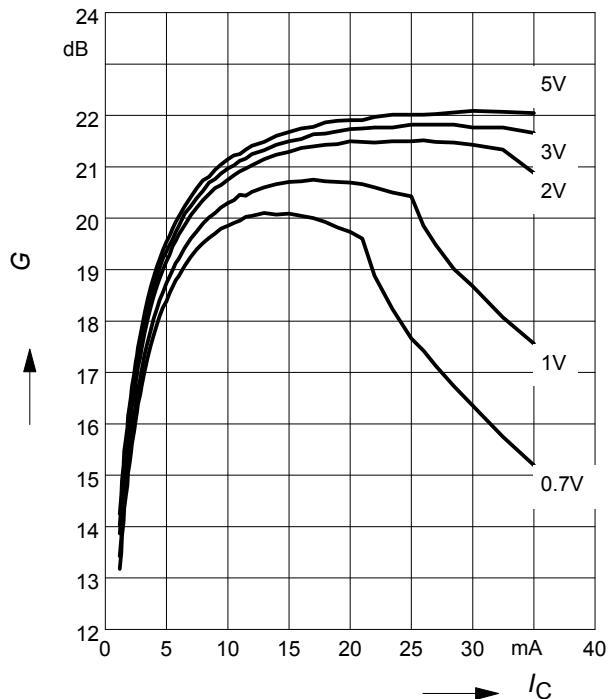
V_{CE} = parameter



Power gain $G_{ma}, G_{ms} = f(I_C)$

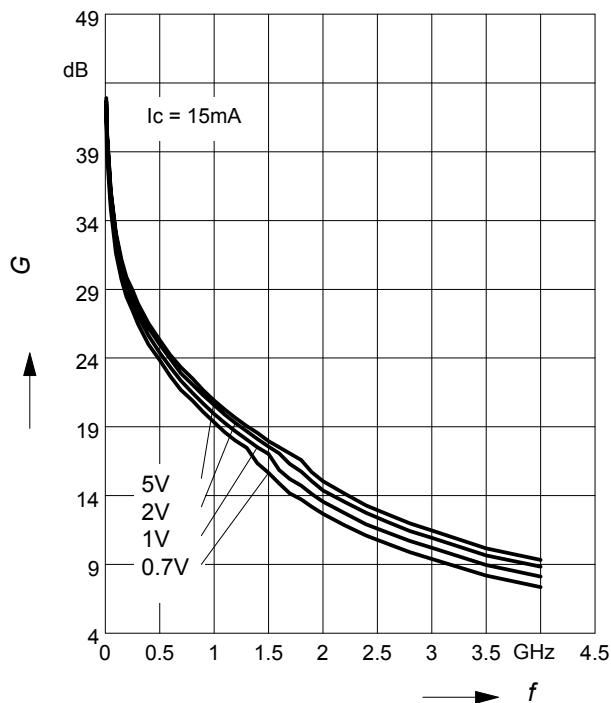
$f = 0.9\text{GHz}$

V_{CE} = parameter



Power Gain $G_{ma}, G_{ms} = f(f)$

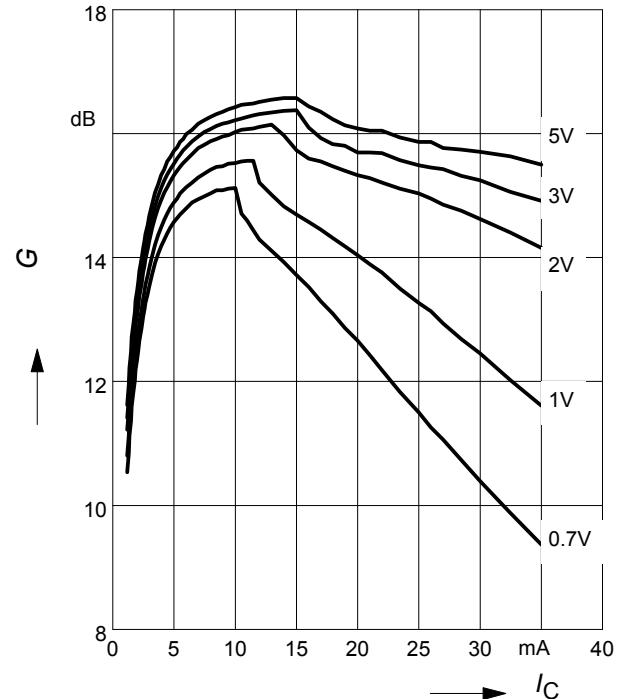
V_{CE} = parameter



Power gain $G_{ma}, G_{ms} = f(I_C)$

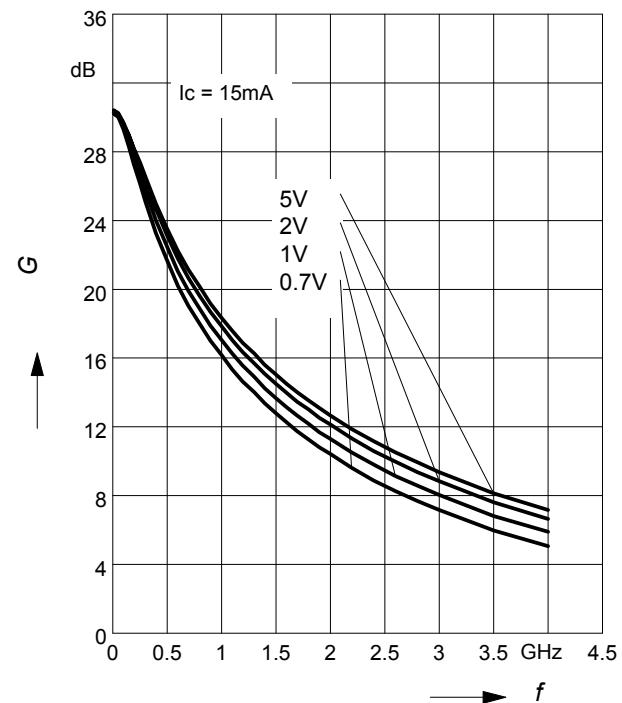
$f = 1.8\text{GHz}$

V_{CE} = parameter



Insertion Power Gain $|S_{21}|^2 = f(f)$

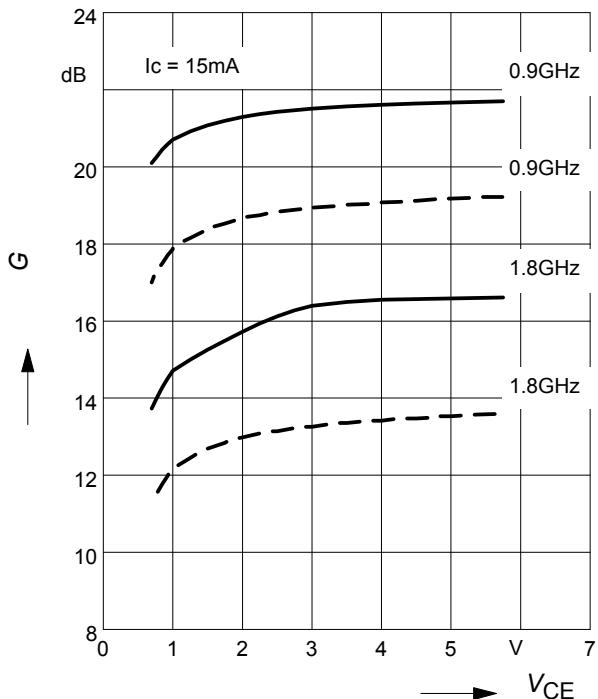
V_{CE} = parameter



Power Gain $G_{\text{ma}}, G_{\text{ms}} = f(V_{\text{CE}})$: —

$|S_{21}|^2 = f(V_{\text{CE}})$: - - -

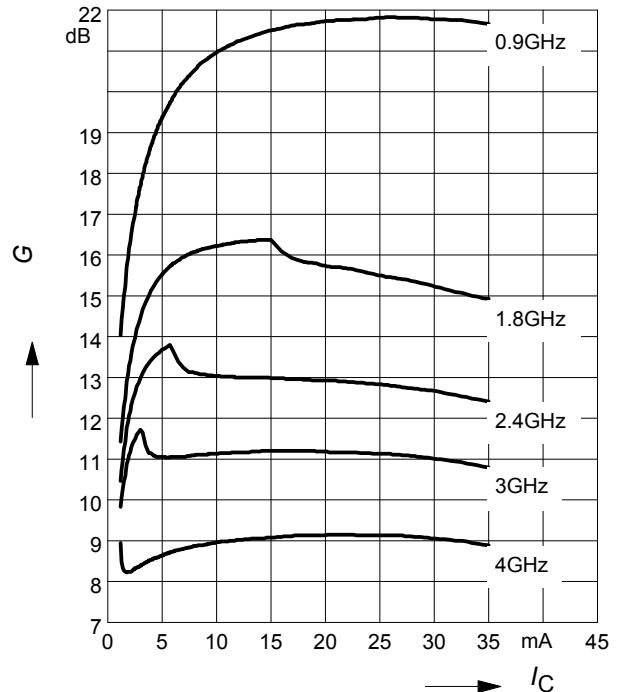
f = parameter



Power gain $G_{\text{ma}}, G_{\text{ms}} = f(I_C)$

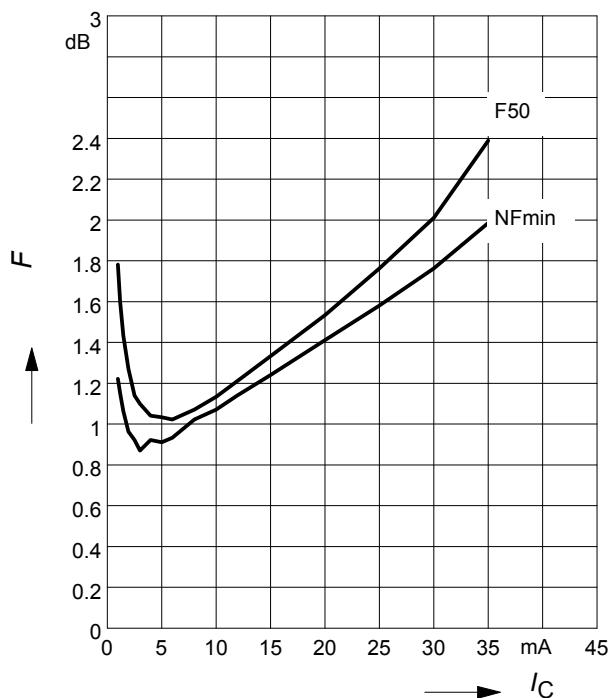
$V_{\text{CE}} = 3\text{V}$

f = parameter



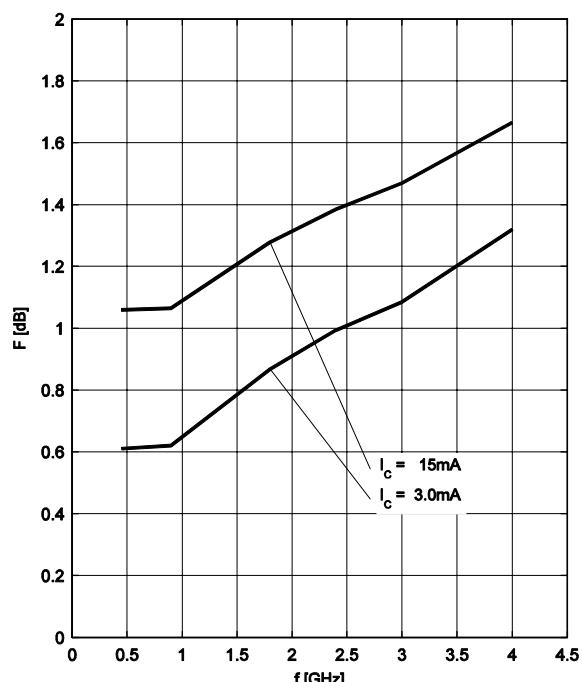
Noise figure $NF = f(I_C)$

$V_{\text{CE}} = 3\text{V}, f = 1.8 \text{ GHz}$



Noise figure $F = f(f)$

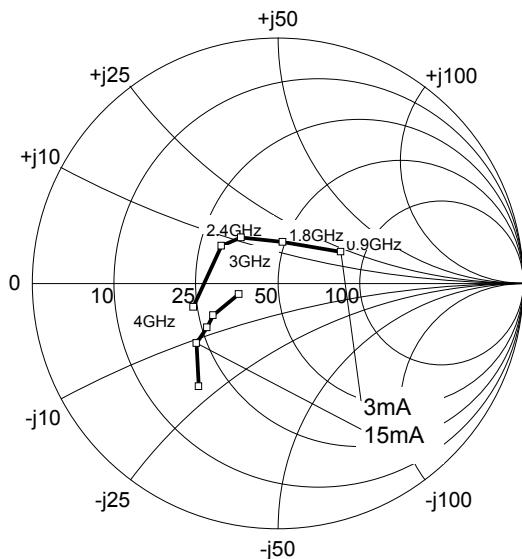
$V_{\text{CE}} = 3\text{V}, Z_S = Z_{\text{Sopt}}$



Source impedance for min.

noise figure vs. frequency

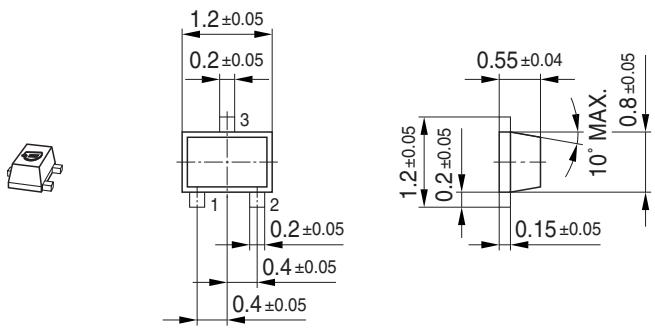
$$V_{CE} = 3 \text{ V}$$



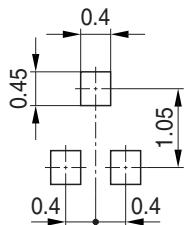
SPICE Parameter

For the SPICE model as well as for the S-parameters (including noise parameters) please refer to our internet website www.infineon.com/rf.models.

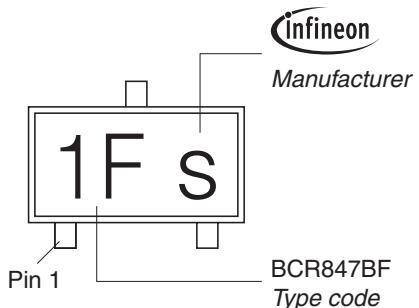
Package Outline



Foot Print

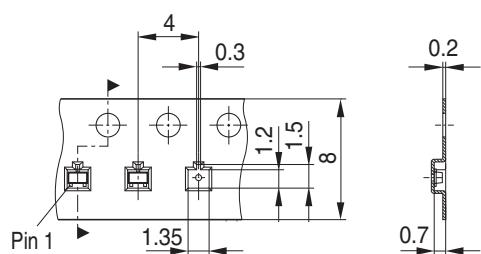


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø330 mm = 10.000 Pieces/Reel



Datasheet Revision History: 20 May 2010

This datasheet replaces the revision from 30 March 2007.

The product itself has not been changed and the device characteristics remain unchanged. Only the product description and information available in the datasheet has been expanded and updated.

Previous Revision: 30 March 2007	
Page	Subject (changes since last revision)
1	Datasheet has final status
1	Max. ratings refer to 25°C
1	Max. rating for T_A removed
1	Lower max. rating for storage temperature T_{Stg} changed
2	Typical values for leakage currents included, maximum leakage current values reduced
6	Characteristic curve for NFmin vs. frequency included

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Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,
Промышленная ул, дом № 19, литер Н,
помещение 100-Н Офис 331